

# 15A, 45V Schottky Barrier Surface Mount Rectifier

### **FEATURES**

- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

### **MECHANICAL DATA**

- Case: TO-263AB (D<sup>2</sup>PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.35g (approximately)

KEY PARAMETERS			
PARAMETER VALUE UN			
I <sub>F</sub>	15	Α	
$V_{RRM}$	45	V	
I <sub>FSM</sub>	150	Α	
T <sub>J MAX</sub>	175	°C	
Package	TO-263AB (D <sup>2</sup> PAK)		
Configuration	Dual dies		

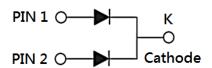








TO-263AB (D<sup>2</sup>PAK)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	MBRS15H45CT	UNIT	
Marking code on the device		MBRS15H45CT		
Repetitive peak reverse voltage	$V_{RRM}$	45	V	
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	31	V	
Forward current	I <sub>F</sub>	15	А	
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	150	А	
Peak repetitive forward current (Rated V <sub>R</sub> , Square wave, 20KHz)	I <sub>FRM</sub>	15	А	
Peak repetitive reverse surge current <sup>(1)</sup>	I <sub>RRM</sub>	1	А	
Critical rate of rise of off-state voltage	dv/dt	10,000	V/µs	
Junction temperature	T <sub>J</sub>	-55 to +175	°C	
Storage temperature	T <sub>STG</sub>	-55 to +175	°C	

#### Notes:

1.  $tp = 2.0\mu s$ , 1.0KHz



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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-case thermal resistance	R <sub>eJC</sub>	2	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	$I_F = 7.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.64	0.68	V
	I <sub>F</sub> = 15.0A, T <sub>J</sub> = 25°C		0.76	0.80	V
	I <sub>F</sub> = 7.5A, T <sub>J</sub> = 125°C		0.55	0.60	V
	I <sub>F</sub> = 15.0A, T <sub>J</sub> = 125°C		0.67	0.70	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 25°C	· I <sub>R</sub>	-	30	μA
	T <sub>J</sub> = 125°C		-	10	mA

# Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
MBRS15H45CT	TO-263AB (D <sup>2</sup> PAK)	800 / Tape & Reel



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

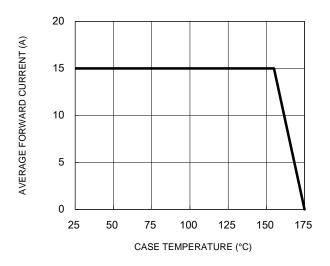


Fig.2 Typical Junction Capacitance

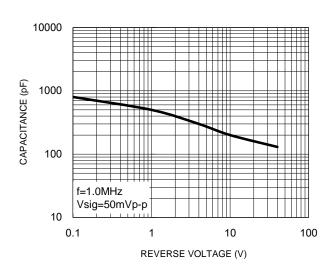
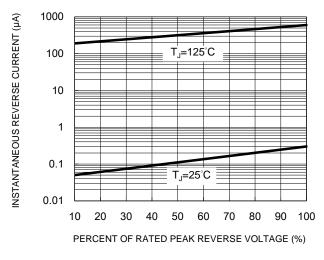


Fig.3 Typical Reverse Characteristics

**Fig.4 Typical Forward Characteristics** 



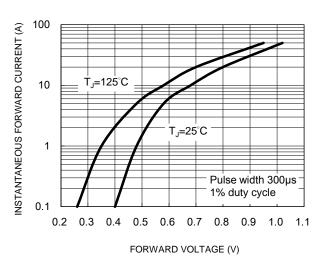
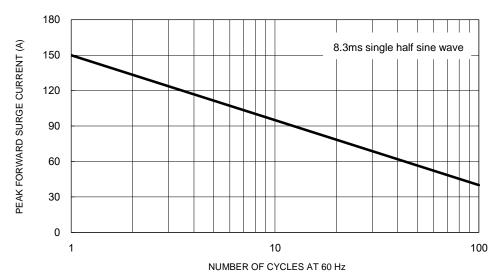


Fig.5 Maximum Non-Repetitive Forward Surge Current



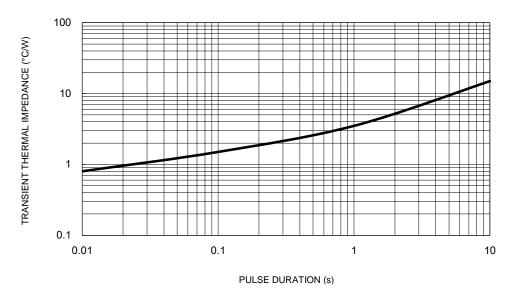
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## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.6 Typical Transient Thermal Impedance

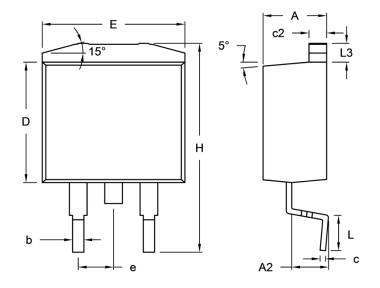






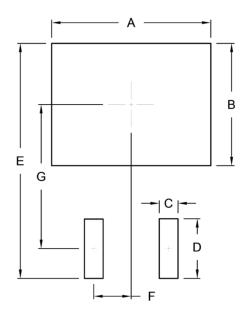
## **PACKAGE OUTLINE DIMENSIONS**

# TO-263AB (D<sup>2</sup>PAK)



DIM.	Unit (mm)		Unit (	Jnit (inch)	
DIN.	Min.	Max.	Min.	Max.	
Α	4.44	4.70	0.175	0.185	
A2	2.03	2.79	0.080	0.110	
b	0.68	0.94	0.027	0.037	
С	0.36	0.53	0.014	0.021	
c2	1.14	1.40	0.045	0.055	
D	8.25	9.25	0.325	0.364	
E	-	10.50	-	0.413	
е	2.41	2.67	0.095	0.105	
Н	14.60	15.88	0.575	0.625	
L	2.29	2.79	0.090	0.110	
L3	1.14	1.40	0.045	0.055	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

## **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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